

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. **(currently amended):** A support for a lithographic printing plate obtained by performing graining treatment including electrochemical graining treatment on an aluminum plate, wherein said aluminum plate contains Fe of 0.05 to 0.29 wt%, Si of 0.03 to 0.15 wt%, Cu of 0.025 to 0.050 wt%, Ti of 0.05 wt% or less, and Mg of less than 0.05 wt% and Zr of 10-40 ppm and the remaining portion thereof is composed of aluminum and unavoidable impurities, said aluminum plate having an aluminum purity of 99.28% 99.6 wt% or more,

wherein said aluminum plate is such that the plate thickness t (mm) thereof is 0.10 to 0.50 (mm) and the relation between said plate thickness t (mm) and the tensile strength TS (MPa) of said aluminum plate in a rolling direction satisfies the following equation [I]

Equation [1]:

$$-98.6 \times t + 170 \leq TS \text{ (MPa)} \leq -98.6 \times t + 200.$$

2. **(canceled).**

3. **(previously presented):** The support for a lithographic printing plate according to claim 1, wherein said aluminum plate is such that for intermetallic compounds existent on the surface thereof, an intermetallic compound with a circle equivalent diameter of 1 μm or more is

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of 6,000 pieces/mm² or less and the rate of an intermetallic compound with a circle equivalent diameter of 1 to 10 µm is 85% or higher.

4. (canceled).

5. (original): The support for a lithographic printing plate according to claim 1, wherein said aluminum plate is such that for crystal grains located in the area up to 50 µm deep from the surface thereof, the width in a direction perpendicular to a plate rolling direction is an average of 80 µm or less and a maximum of 150 µm or less, and the length of the plate rolling direction is an average of 400 µm or less and a maximum of 500 µm or less.

6. (canceled).

7. (original): The support for a lithographic printing plate according to claim 3, wherein said aluminum plate is such that for crystal grains located in the area up to 50 µm deep from the surface thereof, the width in a direction perpendicular to a plate rolling direction is an average of 80 µm or less and a maximum of 150 µm or less, and the length of the plate rolling direction is an average of 400 µm or less and a maximum of 500 µm or less.

8. (original): The support for a lithographic printing plate according to claim 1, wherein Si atom adhesion quantity onto the surface of said aluminum plate is 0.1 to 30 mg/m².

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9. (canceled).

10. (original): The support for a lithographic printing plate according to claim 3, wherein Si atom adhesion quantity onto the surface of said aluminum plate is 0.1 to 30 mg/m².

11. (original): The support for a lithographic printing plate according to claim 5, wherein Si atom adhesion quantity onto the surface of said aluminum plate is 0.1 to 30 mg/m².

12. (original): A presensitized plate provided with an image recording layer on the support for a lithographic printing plate according to claim 1.

13. (canceled).

14. (original): A presensitized plate provided with an image recording layer on the support for a lithographic printing plate according to claim 3.

15. (original): A presensitized plate provided with an image recording layer on the support for a lithographic printing plate according to claim 5.

16. (original): The presensitized plate according to claim 12, which is a presensitized plate for a laser printing plate.

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17. **(original):** A method of treating a presensitized plate, wherein after exposure is performed on the presensitized plate according to claim 12, development is performed with a developer substantially containing no alkali metal silicates and containing saccharides.

18. **(canceled).**

19. **(original):** A method of treating a presensitized plate, wherein after exposure is performed on the presensitized plate according to claim 14, development is performed with a developer substantially containing no alkali metal silicates and containing saccharides.

20. **(original):** A method of treating a presensitized plate, wherein after exposure is performed on the presensitized plate according to claim 15, development is performed with a developer substantially containing no alkali metal silicates and containing saccharides.

21. **(canceled).**